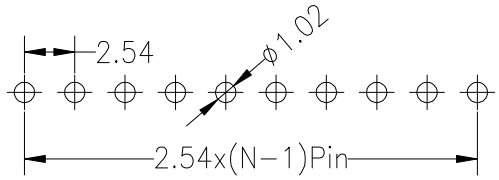
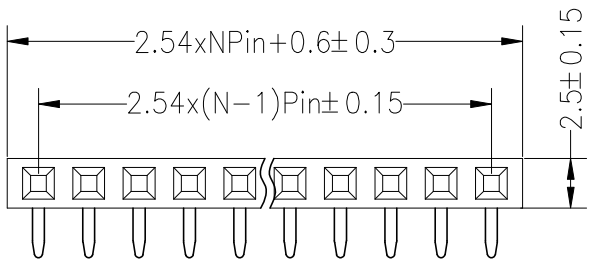
HSF RoHS FILE NO :E362810

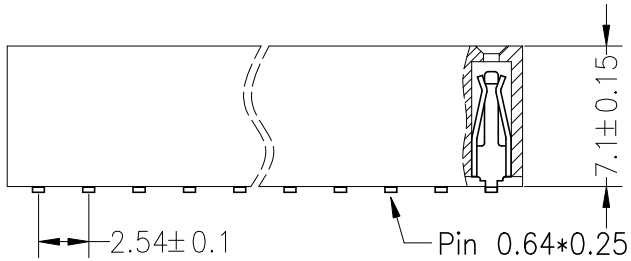
SPECIFICATIONS
Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

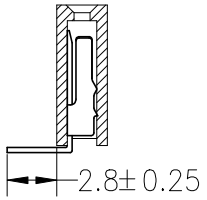
Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)

Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE± 0.05)









Ordering Information

2271 01 XX X N XX R U X 01

- XX — No.of Pins Per Row 1*40
- X — Insulator Material Option
  - A=BK−PBT
  - C=BK−PA6T
  - D=BK−PA46
  - E=BK−PA9T
  - F=BK−LCP
- XX — Contact Plating
  - G1:Gold Flash
  - G2:1.5U" Gold
  - G3:2U" Gold
  - G4:3U" Gold
  - G5:5U" Gold
  - S0:Gold Flash/Tin
  - SN:Tin
- X — Packing
  - 0=PE Bag
  - A=Tray
  - T=Tube
  - P=Tube+Cap
  - R=Reel+Cap
  - M=Reel+Mylar

REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2021.11.11	NEW DRAWING	

OPERATION		DRAW	Liu Miao	2021.11.11	SCALE	FIT
X.X	±0.30				UNIT	mm
X.XX	±0.20	CHECK			SIZE	A4
X.XXX	±0.10				SHEET	1/1
Angle	±3°	APPROVE			PROJ.	
DIM	TOL					

WFD CONN 深圳市旺富达电子有限公司 SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	227101XXXNXXRUX01
TITLE:	2.54PF H7.1mm 1xNpin 90°